

Low Offset Operational Amplifier

PRODUCT DESCRIPTION

The OP07 is a low offset voltage operational amplifier, which uses wafer-level trim to eliminate offset and further reduces offset voltage through external circuit. It also has ultra-low bias current (only 4nA) and high open-loop gain (minimum 200V/mV, 106dB). All of these characteristics make the OP07 suitable to be used as a high-gain instrumentation amplifier.

The OP07 has $\pm 13V$ wide input voltage range, 106dB common-mode rejection ratio (CMRR) and high input impedance. These features make the amplifier high-precise when amplifying signals. Excellent linearity and precision are guaranteed even at high closed-loop gain. The parameters, such as time stability of offset and gain, rate of change with temperature are also excellent. After removal of external offset, the precision and stability of the OP07 make itself become the industry standard for instrument applications.



SOP8



DIP8

FEATURES

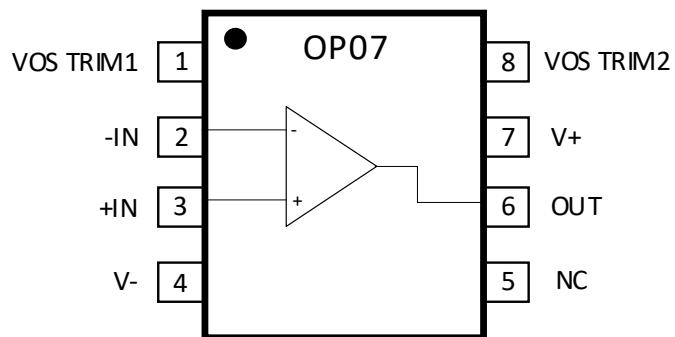
- Low Offset Voltage Drift: $1.3\mu V/^{\circ}C$ (Max)
- Time Stability of Offset Voltage: $1.5\mu V/Month$ (Max)
- Low Noise: $0.6\mu V_{p-p}$ (Max)
- Wide Input Voltage Range: $\pm 14V$ (Typ)
- Wide Power Supply: $\pm 3V$ to $\pm 18V$

APPLICATIONS

- Wireless Base Station Control Circuit
- Optical Fiber Network Control Circuit
- Instrumentation Amplifier
- Sensor and Controller
 - Thermocouple
 - Thermal Resistance Detection
 - Strain Bridge
 - Parallel Current Detection
- Precision Filter

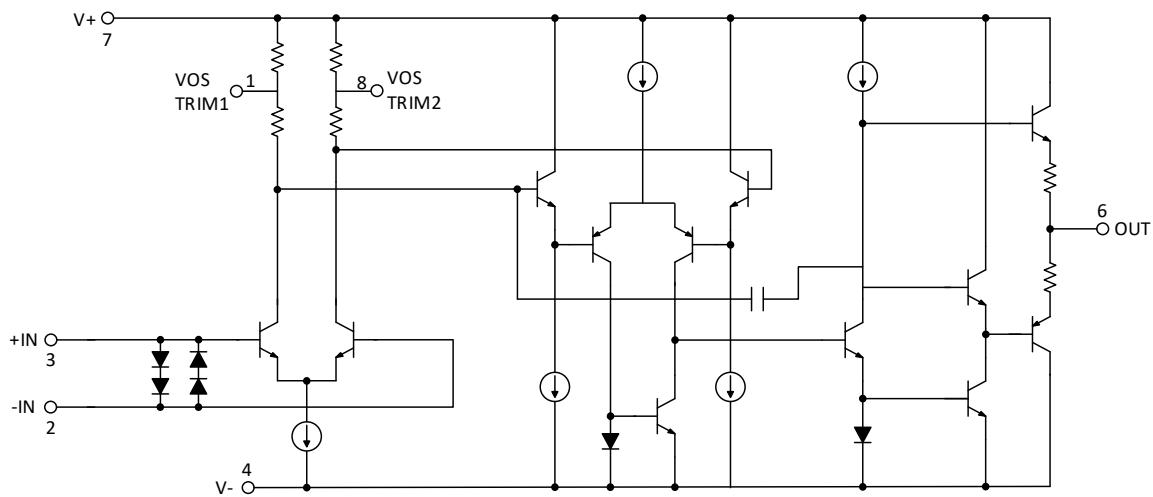
PRODUCT SPECIFICATION

| Part Number | Package | Marking |
|-------------|---------|---------|
| OP07 | SOP8 | OP07 |
| OP07D | DIP8 | OP07D |

PIN CONFIGURATION**PIN DESCRIPTION**

| Pin | Name | Type | Description |
|-----|-----------|------|-----------------------|
| 1 | VOS TRIM1 | IO | Offset Voltage Trim 1 |
| 2 | -IN | I | Negative Input |
| 3 | +IN | I | Positive Input |
| 4 | V- | - | Negative Power Supply |
| 5 | NC | - | Not Connection |
| 6 | OUT | O | Output |
| 7 | V+ | - | Positive Power Supply |
| 8 | VOS TRIM2 | IO | Offset Voltage Trim 2 |

BLOCK DIAGRAM



ABSOLUTE MAXIMUM RATINGS

Any exceeding absolute maximum rating application causes permanent damage to device. Because long-time absolute operation state affects device reliability. Absolute ratings just conclude from a series of extreme tests. It doesn't represent chip can operate normally in these extreme conditions.

| Parameter | Symbol | Ratings | Unit |
|-----------------------------|------------------|------------|------|
| Power Supply | V _S | ±22 | V |
| Input Voltage ¹ | V _{IN} | ±22 | V |
| Differential Input Voltage | V _{IN} | ±30 | V |
| Storage Temperature Range | T _A | -65 ~ +125 | °C |
| Operating Temperature Range | T _{stg} | -40 ~ +85 | °C |
| Junction Temperature | T _J | 150 | °C |
| Lead Temperature | | 300 | °C |

Note 1: When power supply is less than ±22V, the absolute maximum value of input voltage is equal to power supply.

ELECTRICAL CHARACTERISTICS

Unless otherwise noted, $V_S = \pm 15V$.

| Parameter | Symbol | Condition | Min | Typ | Max | Unit |
|------------------------------------|--------------------------|--|------------|------------|-----|----------------------|
| Input Characteristics | | | | | | |
| Input Offset Voltage | V_{OS} | $T_A = 25^\circ C$, Grade A | | | 25 | μV |
| | | $T_A = 25^\circ C$, Grade B | | | 75 | |
| | | $T_A = 25^\circ C$, Grade C | | | 150 | |
| Offset Voltage Long-term Stability | V_{OS}/Time | | | 0.3 | 1.5 | $\mu V/\text{Month}$ |
| Input Offset Voltage Drift | $\Delta V_{OS}/\Delta T$ | $-0^\circ C \leq T_A \leq +70^\circ C$ | | 0.3 | 1.3 | $\mu V/^\circ C$ |
| Input Bias Current | I_B | | | 22 | | nA |
| Input Offset Current | I_{OS} | | | 7 | | nA |
| Input Difference-mode Resistance | R_{IN} | | 15 | 50 | | $M\Omega$ |
| Input Common-mode Resistance | R_{INCM} | | | 160 | | $G\Omega$ |
| Input Voltage Range | ICMR | | ± 13 | ± 14 | | V |
| | | $-0^\circ C \leq T_A \leq +70^\circ C$ | ± 13 | ± 13.5 | | |
| Common-mode Rejection Ratio | CMRR | $V_{CM} = \pm 13V$ | 106 | 123 | | dB |
| | | $-0^\circ C \leq T_A \leq +70^\circ C$ | 103 | 123 | | |
| Large Signal Gain | A_{VO} | $R_L \geq 2k\Omega, V_O = \pm 10V$ | 106 | 114 | | dB |
| | | $R_L \geq 500\Omega, V_O = \pm 10V$ | 103 | 112 | | |
| | | $-0^\circ C \leq T_A \leq +70^\circ C, R_L \geq 2k\Omega, V_O = \pm 10V$ | 105 | 113 | | |
| Output Characteristics | | | | | | |
| Output Voltage Magnitude | V_O | $R_L \geq 10k\Omega$ | ± 12.5 | ± 13.0 | | V |
| | | $R_L \geq 2k\Omega$ | ± 12.0 | ± 12.8 | | |
| | | $R_L \geq 1k\Omega$ | ± 10.5 | ± 12.0 | | |
| | | $-0^\circ C \leq T_A \leq +70^\circ C, R_L \geq 2k\Omega$ | ± 12.0 | ± 12.6 | | |
| Output Short-circuit Current | I_{SC} | | | 21 | | mA |
| Power Supply | | | | | | |
| Power Supply Rejection Ratio | PSRR | $V_S = \pm 3V \text{ to } \pm 18V$ | 94 | 106 | | dB |
| | | $-0^\circ C \leq T_A \leq +70^\circ C$ | 90 | 103 | | |
| Quiescent Power Dissipation | P_Q | $V_S = \pm 15V, \text{ No Load}$ | | 80 | 120 | mW |
| | | $V_S = \pm 3V, \text{ No Load}$ | | 5.5 | 8 | |

| Parameters | Symbol | Condition | Min | Typ | Max | Unit |
|---------------------------------|--------------------|-----------------------|-----|------|------|--------|
| Dynamic Characteristics | | | | | | |
| Gain Bandwidth Product | GBP | Av=1 | 1 | 1.3 | | MHZ |
| Slew Rate | SR | R _L ≥2kΩ | 0.1 | 0.3 | | V/μs |
| Offset Voltage Adjustment Range | | R _P =20kΩ | | ±3.6 | | mV |
| Noise Characteristics | | | | | | |
| Voltage Noise | e _n p-p | 0.1Hz to 10Hz | | 0.35 | 0.6 | μVp-p |
| Voltage Noise Density | e _n | f _o =10Hz | | 10.3 | 18.0 | nV/√Hz |
| | | f _o =100Hz | | 10.0 | 13.0 | |
| | | f _o =1kHz | | 9.6 | 11.0 | |
| Current Noise | I _n p-p | | | 14 | 30 | pAp-p |
| Current Noise Density | I _n | f _o =10Hz | | 0.32 | 0.80 | pA/√Hz |
| | | f _o =100Hz | | 0.14 | 0.23 | |
| | | f _o =1kHz | | 0.12 | 0.17 | |

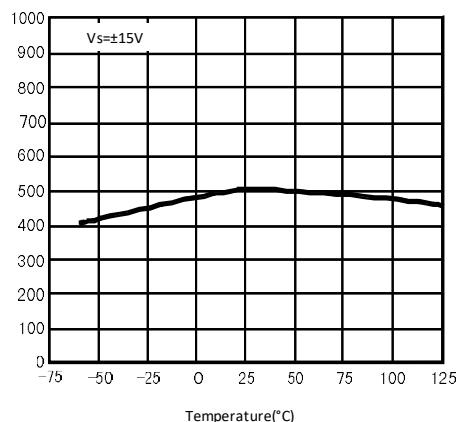
TYPICAL CHARACTERISTICS CURVE


Figure 1. Open-loop Gain VS. Temperature

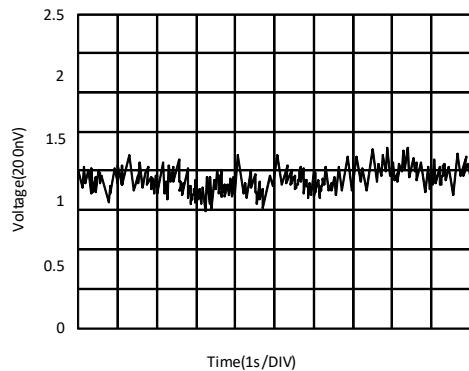


Figure 2. Low-frequency Noise

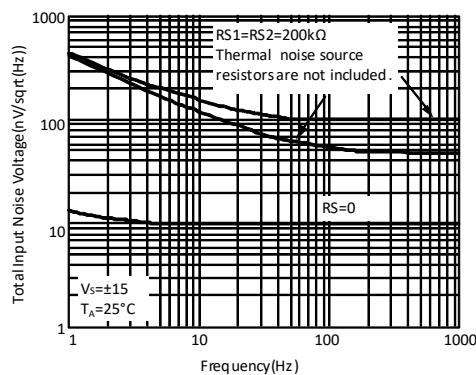


Figure 3. Total Input Noise Voltage VS. Frequency

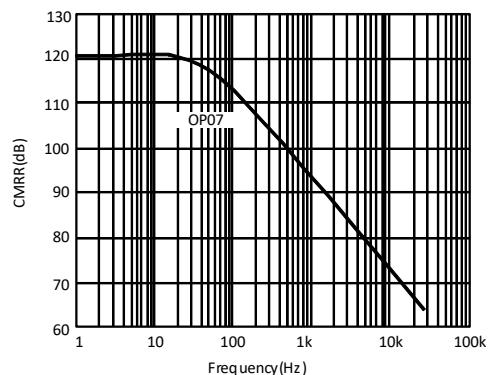


Figure 4. CMRR VS. Frequency

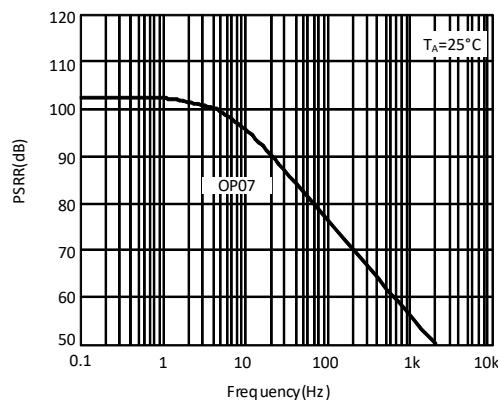


Figure 5. PSRR VS. Frequency

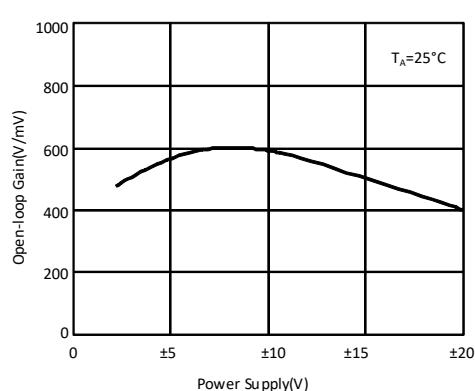


Figure 6. Open-loop Gain VS. Power Supply

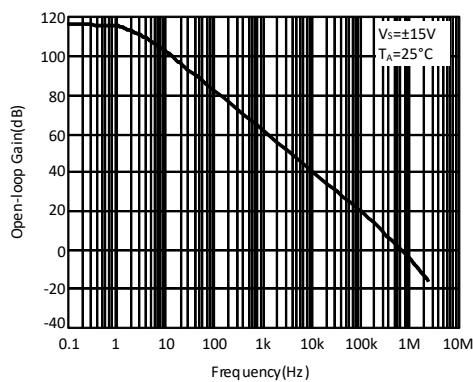


Figure 7. Open-loop Gain Frequency Response

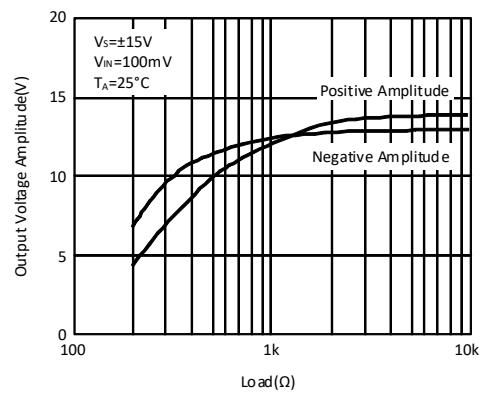


Figure 8. Output Voltage Amplitude VS. Load

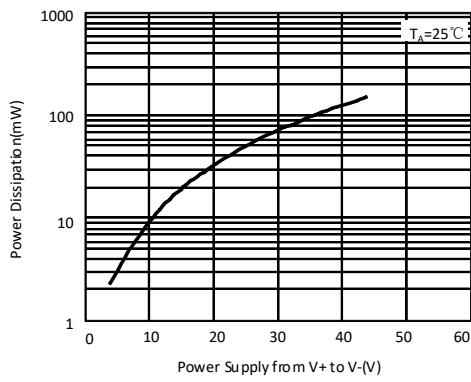


Figure 9. Power Dissipation VS. Power Supply

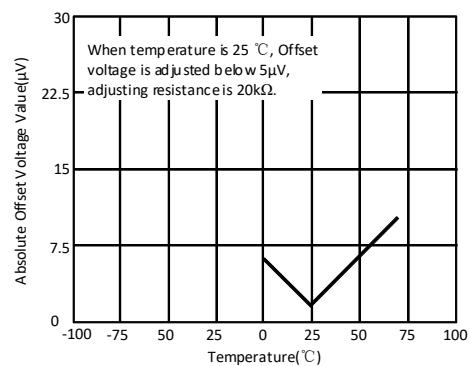


Figure 10. Trimmed Offset Voltage VS. Temperature

TYPICAL APPLICATION

In case of 500pF load capacitance and $\pm 10V$ amplitude, the OP07 can provide stable operating characteristics. And large load capacitance needs to be decoupled by 50Ω resistance.

The stray difference-temperature voltage generated by different metals in touch with the input terminals can deteriorate the drift performance. Therefore, the best operating environment is to keep the two inputs contact at the same temperature. It is better to approach the package temperature.

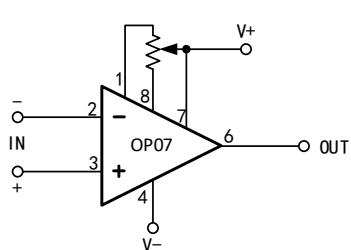


Figure 11. Optical Offset Elimination Circuit

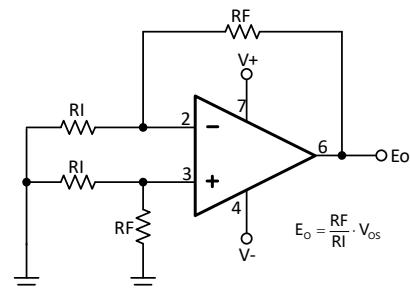


Figure 12. Typical Offset Voltage Measurement Circuit

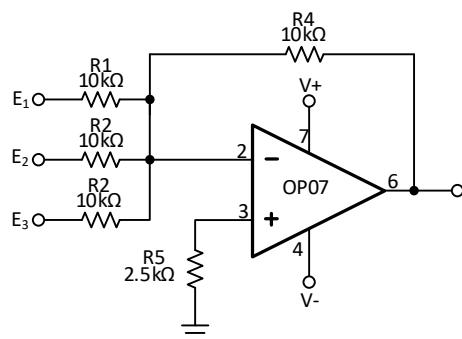


Figure 13. Precise Summing Circuit

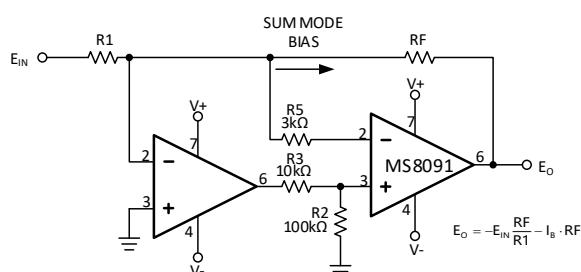


Figure 14. High-speed, Low Offset Compound Amplifier

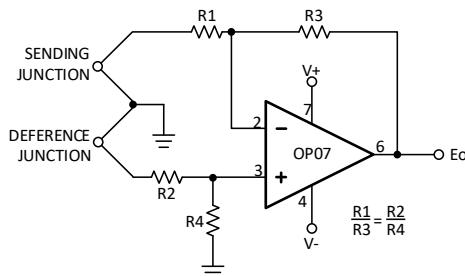


Figure 15. High-Stable Thermocouple Amplifier

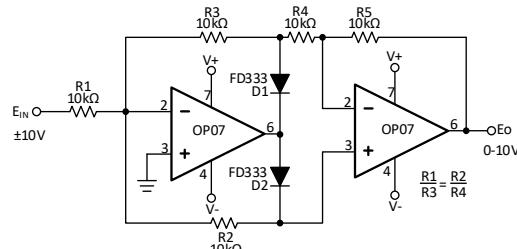
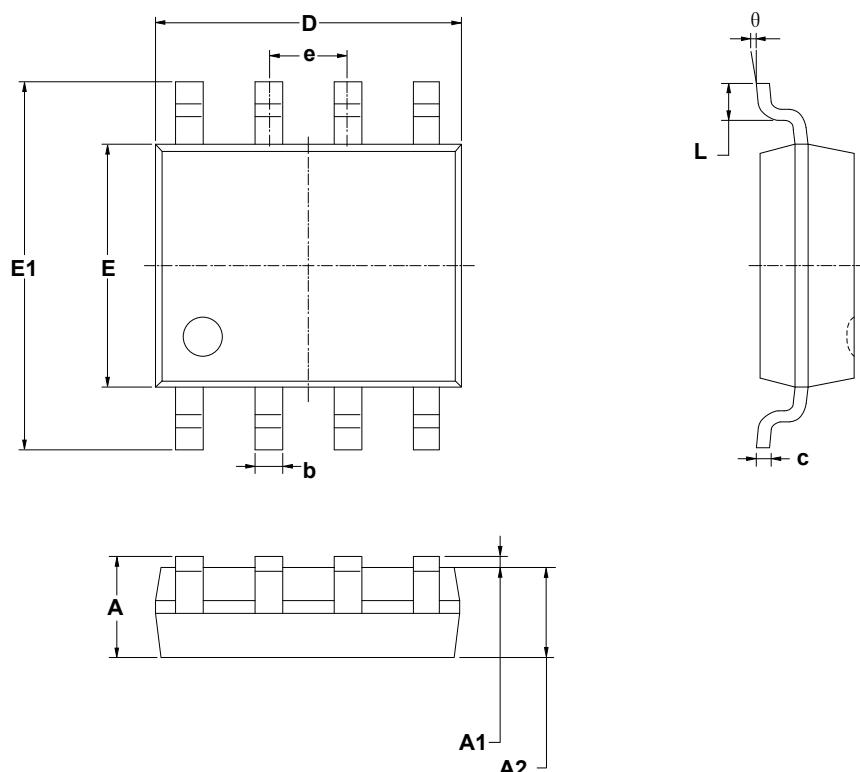


Figure 16. Precise Absolute Value Circuit

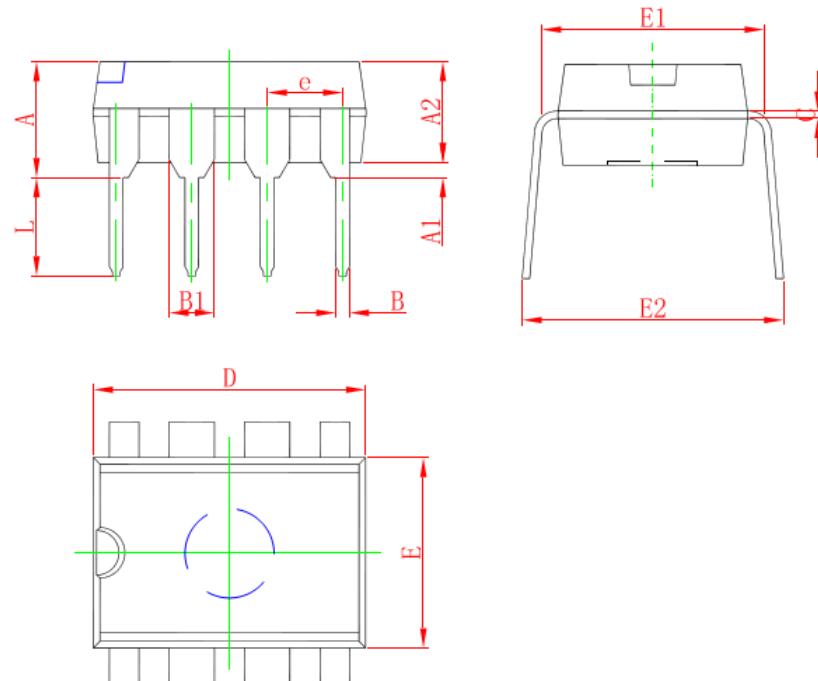
PACKAGE OUTLINE DIMENSIONS

SOP8

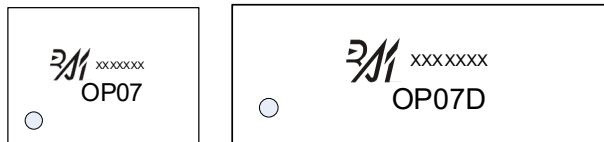


| Symbol | Dimensions in Millimeters | | Dimensions in Inches | |
|--------|---------------------------|-------|----------------------|-------|
| | Min | Max | Min | Max |
| A | 1.350 | 1.750 | 0.053 | 0.069 |
| A1 | 0.100 | 0.250 | 0.004 | 0.010 |
| A2 | 1.350 | 1.550 | 0.053 | 0.061 |
| b | 0.330 | 0.510 | 0.013 | 0.020 |
| c | 0.170 | 0.250 | 0.006 | 0.010 |
| D | 4.700 | 5.100 | 0.185 | 0.200 |
| E | 3.800 | 4.000 | 0.150 | 0.157 |
| E1 | 5.800 | 6.200 | 0.228 | 0.244 |
| e | 1.27(BSC) | | 0.050(BSC) | |
| L | 0.400 | 1.270 | 0.016 | 0.050 |
| θ | 0 ° | 8 ° | 0 ° | 8 ° |

DIP8



| Symbol | Dimensions in Millimeters | | Dimensions in Inches | |
|--------|---------------------------|-------|----------------------|-------|
| | Min | Max | Min | Max |
| A | 3.710 | 4.310 | 0.146 | 0.170 |
| A1 | 0.510 | | 0.020 | |
| A2 | 3.200 | 3.600 | 0.126 | 0.142 |
| B | 0.380 | 0.570 | 0.015 | 0.022 |
| B1 | 1.524(BSC) | | 0.060(BSC) | |
| C | 0.204 | 0.360 | 0.008 | 0.014 |
| D | 9.000 | 9.400 | 0.354 | 0.370 |
| E | 6.200 | 6.600 | 0.244 | 0.260 |
| E1 | 7.320 | 7.920 | 0.288 | 0.312 |
| e | 2.540(BSC) | | 0.100(BSC) | |
| L | 3.000 | 3.600 | 0.118 | 0.142 |
| E2 | 8.400 | | 0.331 | 0.354 |

MARKING and PACKAGING SPECIFICATION**1. Marking Drawing Description**

Product Name: OP07, OP07D

Product Code: XXXXXXXX

2. Marking Drawing Demand

Laser printing, contents in the middle, font type Arial.

3. Packaging Specification

| Device | Package | Piece/Reel | Reel/Box | Piece/Box | Box/Carton | Piece/Carton |
|--------|---------|------------|----------|-----------|------------|--------------|
| OP07 | SOP8 | 2500 | 1 | 2500 | 8 | 20000 |

| Device | Package | Piece/Tube | Tube/Box | Piece/Box | Box/Carton | Piece/Carton |
|--------|---------|------------|----------|-----------|------------|--------------|
| OP07D | DIP8 | 50 | 40 | 2000 | 10 | 20000 |

STATEMENT

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- The process of improving product is endless. And our company would sincerely provide more excellent product for customer.



MOS CIRCUIT OPERATION PRECAUTIONS

Static electricity can be generated in many places. The following precautions can be taken to effectively prevent the damage of MOS circuit caused by electrostatic discharge:

- 1、The operator shall ground through the anti-static wristband.
- 2、The equipment shell must be grounded.
- 3、The tools used in the assembly process must be grounded.
- 4、Must use conductor packaging or anti-static materials packaging or transportation.



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